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SCHIFF HARDIN & WAITE

PATENT DEPARTMENT 6600 SEARS TOWER 233 SOUTH WACKER DRIVE CHICAGO, ILLINOIS 60606

In re application of:

Wydra et al

Serial No.:

09/485,082

GROUP ART UNIT: 1762

Filed:

March 25, 1999

EXAMINER:

M. Barr

For:

"METHOD FOR MANUFACTURING AN

CONFIRMATION NO.: 1453

ADHESION LAYER FOR A HEAT INSULATION LAYER"

AMENDMENT "D"

Assistant Commissioner for Patents Washington D.C. 20231

Transmitted herewith is an amendment in the above-identified application.

■ No additional fee is required.

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The fee has been calculated as shown below.

	RE	(2) CLAIMS MAINING AFTER ENDMENT		(4) HIGHEST NO. PREVIOUSLY PAID FOR	(5) PRESENT EXTRA	(6) RATE	ADDITIONAL FEE
TOTAL CLAIMS	*	20	MINUS	** 20	x	() X 9.00 () X 18.00	
INDEP. CLAIMS	*	2	MINUS	3	x	() X 42.00 () X 84.00	
Application amended to contain any multiple dependent claims not previously paid for					() YES (x) NO	() \$140.00 () \$280.00 ONE TIME	
				TOTAL ADDITIONAL FOR THIS AMENDM	FEE		\$0.0

If the "Highest Number Previously Paid For" IN THIS SPACE is less than 20 write "20" in this space. ☐ Applicant petitions the Commissioner of Patents and Trademarks to extend this time for response to the Office Action months so that the period for response is extended to A check in the amount of \$ is attached to cover the cost of the extension. Any deficiency or overpayment should be charged or credited to deposit account No. 501519. A duplicate copy of this sheet is enclosed. ☐ A check in the amount of \$ is attached. ☐ A check for \$ accompanying IDS under 37 CFR 1.97(c) is attached ☐ A check for \$ and Petition for Consideration of IDS under 37 CFR 1.97(d) is attached. The Commissioner is hereby authorized to charge any additional fees which may be required, or to credit any

overpayment to account No. 501519. A duplicate of this sheet is enclosed. When phoning re this application, please call (312) 258-5781.

> SCHIFF HARDIN & WAITE (Customer Number: 26574) ATENT DEPARTMENT (Reg. No. 24,149)

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on <u>August 21, 2002</u>.

James D/Hobart (Reg. No. 24,149)
NAME OF APPLICANT'S ATTORNEY
SIGNATURE August 21, 2002
DATE





IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

AMENDMENT "D"

APPLICANT:

Wydra et al

GROUP ART UNIT: 1762

SERIAL NO.:

09/485,082

EXAMINER: M. Barr

FILED:

April 19, 2000

CONFIRMATION NO.: 1453

COPY OF PAPERS

INVENTION:

"METHOD FOR MANUFACTURING

AN ADHESION LAYER FOR A

HEAT INSULATION LAYER"

Assistant Commissioner for Patents Washington, D.C. 20231

SIR:

In response to the **Final Rejection** dated May 22, 2002, please amend the above-identified application as follows:

IN THE CLAIMS:

d)

Please amend claim 21 to read as follows:

-21. (Amended) A method for manufacturing an adhesion layer for a heat insulating layer that is applied onto a component part, the method comprising the steps of:

a) producing a slip by mixing powders containing at least one of the elements Cr, Ni or Ce with a binding agent;

b) applying the slip onto the component part to form a slip layer;

c) drying the slip layer at temperatures from room temperature through 300°C;

heat treating the slip layer at a temperature range of 750°C to 1200°C in an atmosphere selected from argon and a vacuum;

e) then alitizing the slip layer to form the adhesion layer, whereby the method is controlled so that the adhesion layer